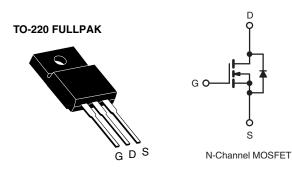


Vishay Siliconix



D Series Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V) at T _J max.	550)
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.85
Q _g (max.) (nC)	30	
Q _{gs} (nC)	4	
Q _{gd} (nC)	7	
Configuration	Sing	le



FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies - SMPS
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	SiHF8N50D-E3

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	500	
Gate-Source Voltage			± 30	V	
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30		
Continuous Drain Current (T ₁ = 150 °C) ^e	V _{GS} at 10 V	T _C = 25 °C	Ι _D	8.7	А
Continuous Drain Current $(1) = 150^{\circ}$ C) ²	VGS at 10 V	$T_C = 100 \ ^\circ C$		5.5	
Pulsed Drain Current ^a			I _{DM}	18	
Linear Derating Factor				0.26	W/°C
Single Pulse Avalanche Energy ^b		E _{AS}	29	mJ	
Maximum Power Dissipation		PD	33	W	
Operating Junction and Storage Temperature Range	Э		T _J , T _{stg}	- 55 to + 150	°C
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt	24	V/ns	
Reverse Diode dV/dt ^d			0.37	v/ns	
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

- b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 2.3 mH, $R_g = 25 \Omega$, $I_{AS} = 5$ Å.
- c. 1.6 mm from case.
- d. $I_{SD} \leq I_D$, starting $T_J = 25$ °C.
- e. Limited by maximum junction temperature.

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For technical questions, contact: hvm@vishay.com

COMPLIANT

1



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	65	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	3.8	0/10

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•			•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	: V _{GS} , I _D = 250 μΑ	3	-	5	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 30 V	-	-	± 100	nA
Zero Coto Voltago Drein Current		V _{DS} =	$V_{DS} = 500 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 4 A$	-	0.70	0.85	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS}	= 20 V, I _D = 4 A	-	3	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$		527	-	
Output Capacitance	C _{oss}	,	$V_{\rm DS} = 100 \rm V,$	-	52	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz		8	-	pF
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	46	-	
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	64	-	
Total Gate Charge	Qg			-	15	30	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 4 \text{ A}, V_{DS} = 400 \text{ V}$	-	4	-	nC
Gate-Drain Charge	Q _{gd}			-	7	-	
Turn-On Delay Time	t _{d(on)}			-	13	26	
Rise Time	t _r	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 4 \text{ A}$ $\text{R}_{g} = 9.1 \Omega, \text{ V}_{\text{GS}} = 10 \text{ V}$		-	16	32	
Turn-Off Delay Time	t _{d(off)}			-	17	34	- ns
Fall Time	t _f				11	22	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	1.8	-	Ω
Drain-Source Body Diode Characteristic	s	<u>.</u>					
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8	
Pulsed Diode Forward Current	I _{SM}			-	-	32	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °	C, I _S = 4 A, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	308	-	ns
Reverse Recovery Charge	Q _{rr}		T _J = 25 °C, $I_F = I_S = 4 A$, dl/dt = 100 A/µs, $V_B = 20 V$		1.8	-	μC
Reverse Recovery Current	I _{RRM}		$100 \text{ Av} \mu\text{s}, \text{ v}_{\text{R}} = 20 \text{ v}$	-	11	-	A

Note

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



SiHF8N50D

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

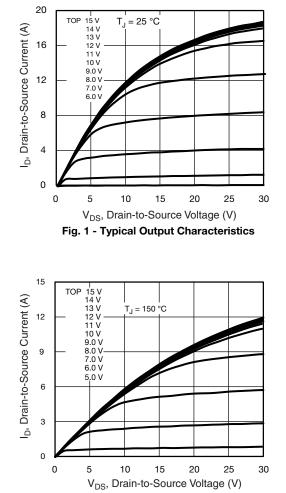
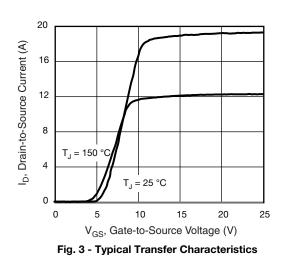


Fig. 2 - Typical Output Characteristics



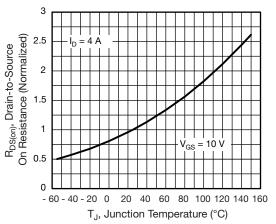


Fig. 4 - Normalized On-Resistance vs. Temperature

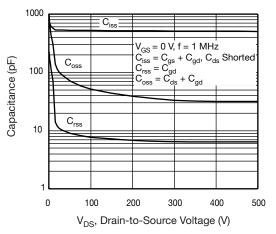


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

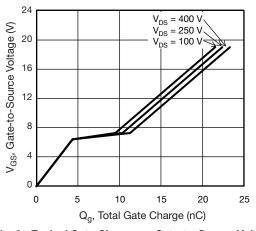


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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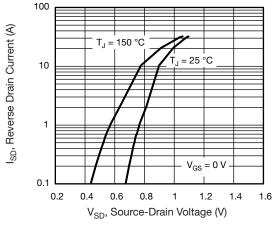
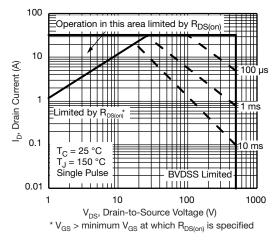


Fig. 7 - Typical Source-Drain Diode Forward Voltage





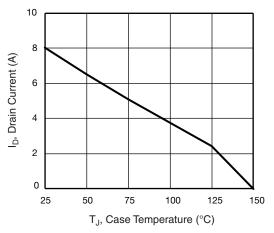


Fig. 9 - Maximum Drain Current vs. Case Temperature

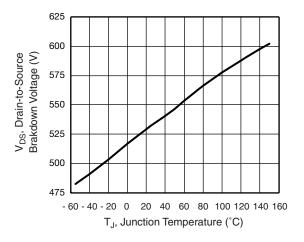
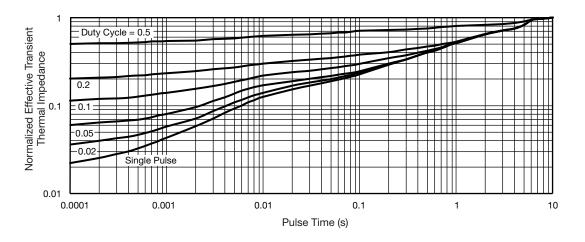


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





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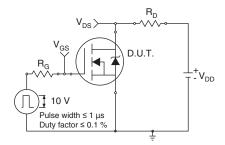


Fig. 12 - Switching Time Test Circuit

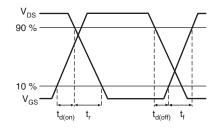


Fig. 13 - Switching Time Waveforms

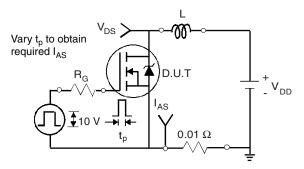


Fig. 14 - Unclamped Inductive Test Circuit

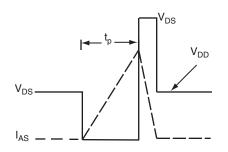


Fig. 15 - Unclamped Inductive Waveforms

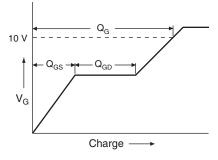


Fig. 16 - Basic Gate Charge Waveform

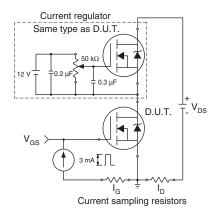
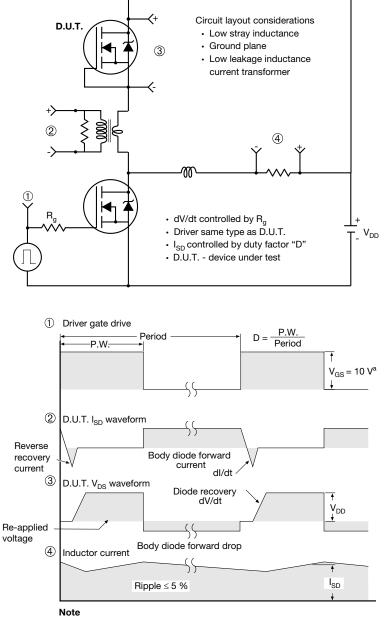


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

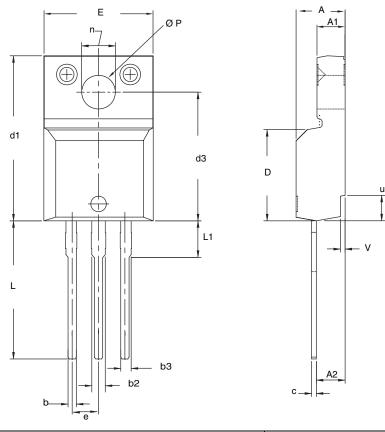
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Package Information

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TO-220 FULLPAK (HIGH VOLTAGE)



	MILLIN	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100	BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØР	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$.

4. All dimensions include burrs and plating thickness.

5. No chipping or package damage.



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